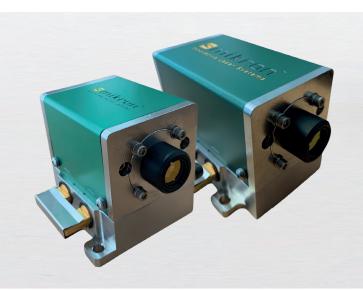
## **High Power**

# 2 μm DPSSL Modules



- · Compact monolithic laser systems
- · Highly efficient diode pumping
- · Fiber-coupled versions available
- · No high-voltage required
- · Reduced waste heat
- · Maintenance free
- · Process variability



### **Specifications**

	DPM-25 (Tm:YAG) free / fiber [1]	DPM-50 (Tm:YAG) free / fiber [1]	DPM-100 (Tm:YAG) free / fiber [1]
Optical Parameters			
<ul> <li>Wavelength</li> <li>Average Output Power (max)</li> <li>Pulse Energy (max)</li> <li>Pulse Repetition Rate (max)</li> <li>Pulse Duration</li> <li>Average Current (max)</li> <li>Mode of Operation</li> <li>Efficiency (optical-optical)</li> <li>Beam Shape (focus)</li> <li>Free Beam Quality</li> <li>Free Beam Diameter</li> <li>Free Divergence (half angle)</li> <li>Fiber Diameter</li> </ul>	(0.2 - 1.6 <sup>[2]</sup> ) / (0.16 - 1,28 <sup>[2]</sup> ) J 500 Hz (100 - 500) (20 000 <sup>[2]</sup> ) µs 7.5 A Pulsed > 15 % Top Hat like M <sup>2</sup> < 20 1.6 mm	2020 nm 50 / 40 W (0.5 - 4 <sup>(2)</sup> ) / (0.4 - 3.2 <sup>(2)</sup> ) J 500 Hz (100 - 500) (20 000 <sup>(2)</sup> ) μs 7.5 A Pulsed > 20 % Top Hat like M² < 30 1.6 mm < 30 mrad ~ 250 μm (NA < 0.2)	2020 nm 100 / 80 W (1 - 8 <sup>[2]</sup> ) / (0.8 - 6.4 <sup>[2]</sup> ) J 500 Hz (100 - 500) (20 000 <sup>[2]</sup> ) μs 7.5 A Pulsed > 20 % Top Hat like M <sup>2</sup> < 40 1.6 mm < 40 mrad ~ 450 μm (NA < 0.2)
Cooling Requirements			
<ul> <li>Coolant</li> <li>Coolant Temperature</li> <li>Coolant Flow Rate</li> <li>Coolant Pressure</li> <li>Required Cooling Power</li> </ul>	Distilled Water with Algaecide and Corrosion Inhibitor 25 °C ≥ 4 lpm (2 - 5) bar ≥ 350 W @ 25 °C Environment Temperature	Distilled Water with Algaecide and Corrosion Inhibitor 25 °C ≥ 5 lpm (3 - 5) bar ≥ 500 W @ 25 °C Environment Temperature	Distilled Water with Algaecide and Corrosion Inhibitor 25 °C ≥ 6 lpm (3 - 5) bar ≥ 750 W @ 25 °C Environment Temperature
Electrical Parameters			
<ul><li>Diode Forward Voltage</li><li>Diode Forward Current (max)</li><li>Average Power Consumption</li></ul>		< 75 V 150 A Pulsed < 750 W	< 130 V 150 A Pulsed < 1000 W
Mechanical Dimensions • Dimension (L x W x H)	(59 x 78 x 59) mm <sup>3 (3)</sup>	(90 x 78 x 59) mm <sup>3 (3)</sup>	(90 x 78 x 59) mm <sup>3 (3)</sup>
· Weight · Emission Height	1 kg 38.1 mm	1 kg 38.1 mm	1 kg 38.1 mm

<sup>[1]</sup> Fiber as specified by Pantec

<sup>[2]</sup> With Pantec Ultrapulse Mode (on request only)

<sup>[3]</sup> Dimensions for bare modules



#### Laser Diode Drivers

The LDD series are economic QCW laser diode driver modules designed to provide high current pulses to drive 2m.i.k.r.o.n.™ laser modules in various applications. The drivers deliver output currents up to 300 A and pulse widths variable from 50 µs up to 20 ms operation <sup>[3]</sup>. Up to 1000 W average output power is available with the supplied heatsink. Several safety features are integrated to protect both, laser module and laser driver.

	DPM-25 (Tm:YAG)	DPM-50/100 (Tm:YAG)	
Laser Diode Driver (3)	LDD-38200	LDD-140300	
· Output Current	up to 200 A	up to 300 A	
· Rise Time (10 - 90)%	< 20 µs	< 20 µs	
<ul> <li>Mechanical Dimensions (W x D x H)</li> </ul>	(200 x 150 x 130) mm <sup>3</sup>	(265 x 150 x 210) mm <sup>3</sup>	
<ul> <li>Additional Features</li> </ul>	Safety circuit and	Safety circuit and	
	communication interface	communication interface	

<sup>(3)</sup> With Pantec Ultrapulse Mode (on request only)

#### Test and Evaluate



The 2m.i.k.r.o.n.™ evalution kits are ready-to-use and straightforward laboratory systems for first feasibility studies in research environment. The evaluation kits are available with different kinds of laser sources (see front page), shortens the development time, enables flexibility and a fast demonstration of feasibility. The test systems are delivered with your requested laser source, a laser control system and a cooling system for laboratory use only.

Please contact us for more information on rental or purchase conditions: info@pantec-biosolutions.com

#### 2m.i.k.r.o.n.™ Applications

Medical	Industrial
· Aesthetics / Dermatology	<ul> <li>Material processing (drilling, cutting, melting, welding, evaporation)</li> </ul>
· Dentistry	· Analytics
· ENT	· Security
· Lithotripsy	· Defense
· Minimally-Invasive Surgery	
· Orthopedics	
· etc.	